



Analog.6834

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**APPLICANT:** Gormley et al. **GROUP:** 2822  
**SERIAL NO:** 10/617,427 **EXAMINER:** P.E. Perkins  
**FILED:** July 11, 2003  
**FOR:** A METHOD FOR FORMING A MICRO-MECHANICAL  
COMPONENT IN A SEMICONDUCTOR WAFER, AND A  
SEMICONDUCTOR WAFER COMPRISING A MICRO-  
MECHANICAL COMPONENT FORMED THEREIN

**Mail Stop Amendment**  
**Commissioner of Patents**  
**P.O. Box 1450**  
**Alexandria, VA 22313-1450**

**Sir:**

**AMENDMENT**

In response to the Office Action mailed February 7, 2005, please amend the above-identified application as indicated on the attached sheets.